

Page 1

TSL2540

ALS, Light-to-Digital Sensor

General Description

The TSL2540 is a very-high sensitivity light-to-digital converter that transforms light intensity into a digital signal output capable of direct I²C interface. The ALS sensor features 2 output channels, a visible channel and an IR channel. The visible channel has a photodiode with a UV and IR blocking filter whereas the IR channel has a photodiode with an IR pass filter. Each channel has a dedicated data converter producing a 16-bit output. This architecture allows applications to accurately measure ambient light which enables devices to calculate illuminance to control a display backlight.

Ordering Information and Content Guide appear at end of datasheet.

Key Benefits & Features

The benefits and features of TSL2540, ALS, Light-to-Digital Sensor are listed below:

Figure 1: **Added Value of Using TSL2540**

| Benefits | Features |
|-------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------|
| Single device integrated optical solution | 2.0mm x 2.0mm x 0.5mm Power management features I²C fast mode interface compatible |
| Accurate ambient light sensing | Photopic ambient light sense (ALS) UV / IR blocking filter Programmable gain and integration time |
| Reduced power consumption | • 1.8V power supply with 1.8V I ² C bus |



Applications

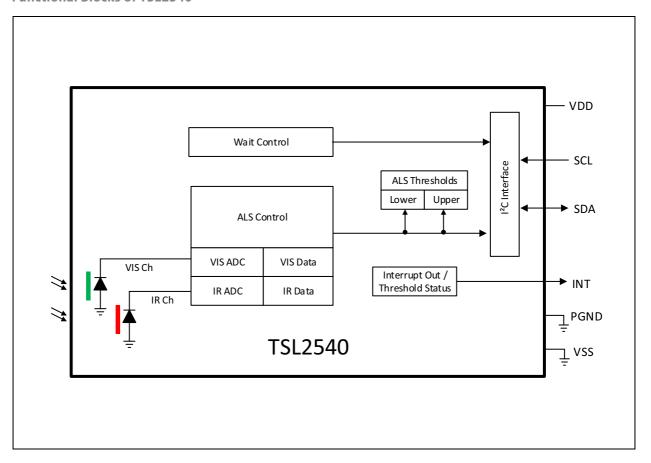
The TSL2540 applications include:

- Ambient light sensing
- Display backlight control

Block Diagram

The functional blocks of this device are shown below:

Figure 2: Functional Blocks of TSL2540



Page 2ams DatasheetDocument Feedback[v1-01] 2017-Oct-12



Pin Assignment

Figure 3: Pin Diagram of TSL2540

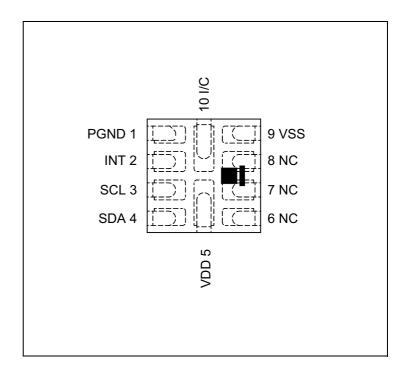


Figure 4: Pin Description of TSL2540 (10-Pin QFN)

| Pin Number | Pin Name | Description | |
|------------|----------|----------------------------------------------------------|--|
| 1 | PGND | Power ground | |
| 2 | INT | Interrupt. Open drain output (active low) | |
| 3 | SCL | I ² C serial clock input terminal | |
| 4 | SDA | I ² C serial data I/O terminal | |
| 5 | VDD | Supply voltage | |
| 6 | NC | No connection | |
| 7 | NC | No connection | |
| 8 | NC | No connection | |
| 9 | VSS | Ground. All voltages are referenced to VSS | |
| 10 | I/C | Internal connection. Connect to ground or leave floating | |

ams Datasheet Page 3
[v1-01] 2017-Oct-12 Document Feedback



Absolute Maximum Ratings

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under Electrical Characteristics is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Figure 5:
Absolute Maximum Ratings

| Symbol | Parameter | Min | Max | Units | Comments |
|--------------------|---------------------------------------------------|--------|-------|-------|--------------------------------------|
| V _{DD} | Supply voltage | -0.3 | 2.2 | V | All voltages are with respect to GND |
| V _{IO} | Digital I/O terminal voltage | -0.3 | 3.6 | V | INT, SCL and SDA |
| l _{out} | Output terminal current | -1 | 20 | mA | INT and SDA |
| T _{strg} | Storage temperature range | -40 | 85 | °C | |
| I _{SCR} | Input current (latch up immunity) JEDEC JESD78D | ± | ± 100 | | Class II |
| ESD _{HBM} | Electrostatic discharge HBM JS-001-2014 | ± 2000 | | V | |
| ESD _{CDM} | Electrostatic discharge CDM JEDEC JESD22-C101F | ± : | 500 | V | |

Page 4ams DatasheetDocument Feedback[v1-01] 2017-Oct-12



Electrical Characteristics

All limits are guaranteed. The parameters with min and max values are guaranteed with production tests or SQC (Statistical Quality Control) methods.

Figure 6: **Recommended Operating Conditions**

| Symbol | Parameter | Min | Тур | Max | Units |
|----------------|---------------------------------------------------------------------------|-----|-----|-----|-------|
| V_{DD} | Supply voltage | 1.7 | 1.8 | 2.0 | V |
| | Supply voltage accuracy, V _{DD} total error including transients | -3 | | 3 | % |
| T _A | Operating free-air temperature (1) | -30 | | 85 | °C |

Note(s):

1. While the device is operational across the temperature range, performance will vary with temperature. Specifications are stated at 25°C unless otherwise noted.

Figure 7: Operating Characteristics, V_{DD} = 1.8V, T_A = 25°C

| Symbol | Parameter | Conditions | Min | Тур | Max | Units |
|--------------------------------|------------------------------------------------------------------|-------------------------------------|------|-------|------|-------|
| f _{OSC} | Oscillator frequency | | | 8.107 | | MHz |
| | | Active ALS State (PON=AEN=1) (1) | 50 | 90 | 150 | |
| I _{DD} Supply current | | Idle State (PON=1,AEN=0) (2) | | 30 | 60 | μΑ |
| | | Sleep State (3) | | 0.7 | 5 | |
| V _{OL} | INT, SDA output low voltage | 6mA sink current | | | 0.6 | V |
| I _{LEAK} | Leakage current, INT, SCL and SDA | | -5 | | 5 | μΑ |
| V _{IH} | SCL, SDA input high voltage (4) | | 1.26 | | | V |
| V _{IL} | SCL, SDA input low voltage | | | | 0.54 | V |
| T _{Active} | Time from power-on to ready to receive I ² C commands | | | 1.5 | | ms |

Note(s):

- 1. This parameter indicates the supply current during periods of ALS integration. If Wait is enabled (WEN=1), the supply current is lower during the Wait period.
- 2. Idle state occurs when PON=1 and all functions are not enabled.
- 3. Sleep state occurs when PON = 0 and I^2C bus is idle. If Sleep state has been entered as the result of operational flow, SAI = 1, PON will remain high.

4. Digital pins: SDA, SCL, INT, are tolerant to a communication voltage up to 3.0V.

ams Datasheet Page 5 **Document Feedback**



Typical Operating Characteristics

Figure 8:

ALS Operating Characteristics, $V_{DD} = 1.8V$, $T_A = 25$ °C

| Parameter | Conditions | Min | Тур | Max | Units | | | |
|-------------------------------------------|--------------------------------------------------------------|-----------|-------|------|----------------------------------|--|--|--|
| Integration time step size | | 2.68 | 2.78 | 2.90 | ms | | | |
| Number of integration steps | | 1 | | 256 | steps | | | |
| Dark ADC count value | $E_e = 0 \mu W/ cm^2$; AGAIN = 64x; ATIME = 100ms (0xDC) | 0 | 1 | 3 | counts | | | |
| | Vis | sible Cha | nnel | | | | | |
| R _e Irradiance responsivity | White LED, 2700K | 309 | 363 | 417 | counts/ (μW/cm ²) | | | |
| Settings: AGAIN = 16x | IR Channel | | | | | | | |
| ATIME = 400ms | $\lambda_D = 950 \text{ nm LED}$ | | 352 | | counts/ (μW/cm ²) | | | |
| | AGAIN = 4x | | 4 | | | | | |
| Gain scaling, relative to 1x | AGAIN = 16x | | 16 | | X | | | |
| gain setting | AGAIN = 64x | | 67 | | * | | | |
| | AGAIN = 128x | | 140 | 40 | | | | |
| ADC noise | AGAIN = 16x | | 0.005 | | % full scale | | | |

Page 6ams DatasheetDocument Feedback[v1-01] 2017-Oct-12



Figure 9: Spectral Responsivity

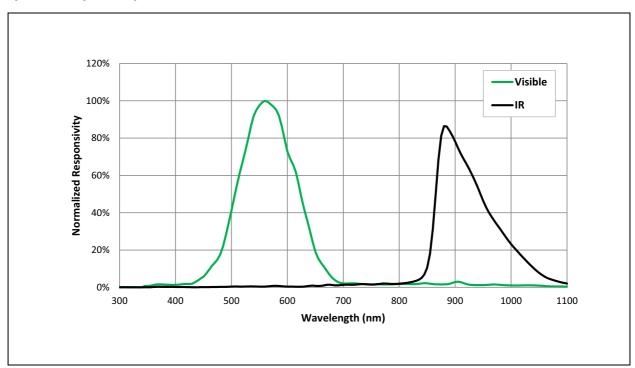
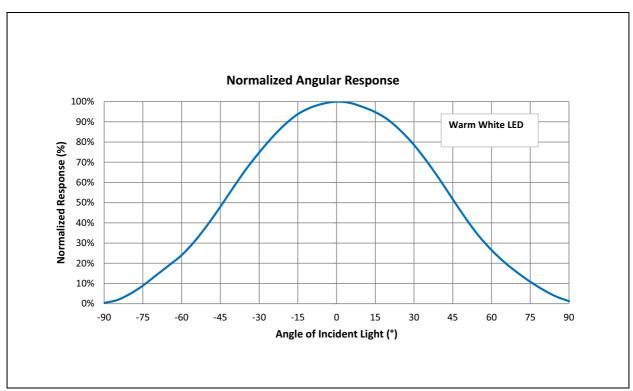


Figure 10: ALS Responsivity vs Angular Displacement



ams Datasheet Page 7
[v1-01] 2017-Oct-12 Document Feedback



Detailed Description

Ambient Light Sensing

The ALS reception signal path begins as photodiodes receive filtered light and ends with the 16-bit results in the VISDATAL/H and IRDATAL/H registers. The visible channel's photodiode is filtered with a UV and IR filter to receive only visible light. The IR channel's photodiode is filtered to receive only IR. Signals from the photodiodes simultaneously accumulate for a period of time set by the value in ATIME before the results are available. Gain is adjustable from 1x to 128x to facilitate operation over a wide range of lighting conditions. Custom Lux equations can be created for specific applications and system designs.

I²C Characteristics

The device uses I²C serial communication protocol for communication. The device supports 7-bit chip addressing and both standard and fast clock frequency modes with a chip address of 0x39. Read and Write transactions comply with the standard set by Philips (now NXP).

Internal to the device, an 8-bit buffer stores the register address location of the desired byte to read or write. This buffer auto-increments upon each byte transfer and is retained between transaction events (i.e. valid even after the master issues a STOP command and the I²C bus is released).

During consecutive Read transactions, the future/repeated I^2C Read transaction may omit the memory address byte normally following the chip address byte; the buffer retains the last register address + 1.

I²C Write Transaction

A Write transaction consists of a START, CHIP-ADDRESS_{WRITE}, REGISTER-ADDRESS, DATA BYTE(S), and STOP. Following each byte (9th clock pulse) the slave places an ACKNOWLEDGE/NOT-ACKNOWLEDGE (ACK/NACK) on the bus. If NACK is transmitted by the slave, the master may issue a STOP.

I²C Read Transaction

A Read transaction consists of a START, CHIP-ADDRESS $_{WRITE}$, REGISTER-ADDRESS, START, CHIP-ADDRESS $_{READ}$, DATA BYTE(S), and STOP. Following all but the final byte the master places an ACK on the bus (9TH clock pulse). Termination of the Read transaction is indicated by a NACK being placed on the bus by the master, followed by STOP.

Alternately, if the previous I²C transaction was a Read, the internal register address buffer is still valid, allowing the transaction to proceed without "re"-specifying the register address. In this case the transaction consists of a START, CHIP-ADDRESS_{READ}, DATA BYTE(S), and STOP. Following all but

Page 8

Document Feedback

[v1-01] 2017-Oct-12



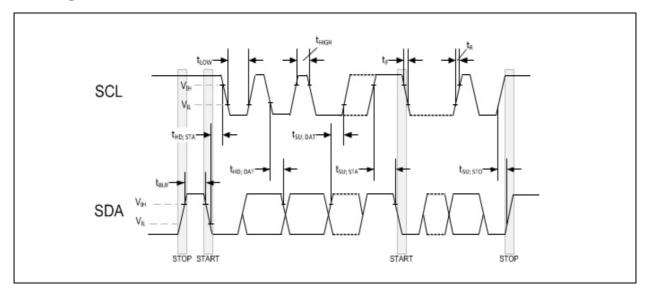
the final byte the master places an ACK on the bus (9th clock pulse). Termination of the Read transaction is indicated by a NACK being placed on the bus by the master, followed by STOP.

The I²C bus protocol was developed by Philips (now NXP). For a complete description of the I²C protocol, please review the NXP I²C design specification at:

www.i2c-bus.org/references/

Timing Diagrams

Figure 11: I²C Timing



Principles of Operation

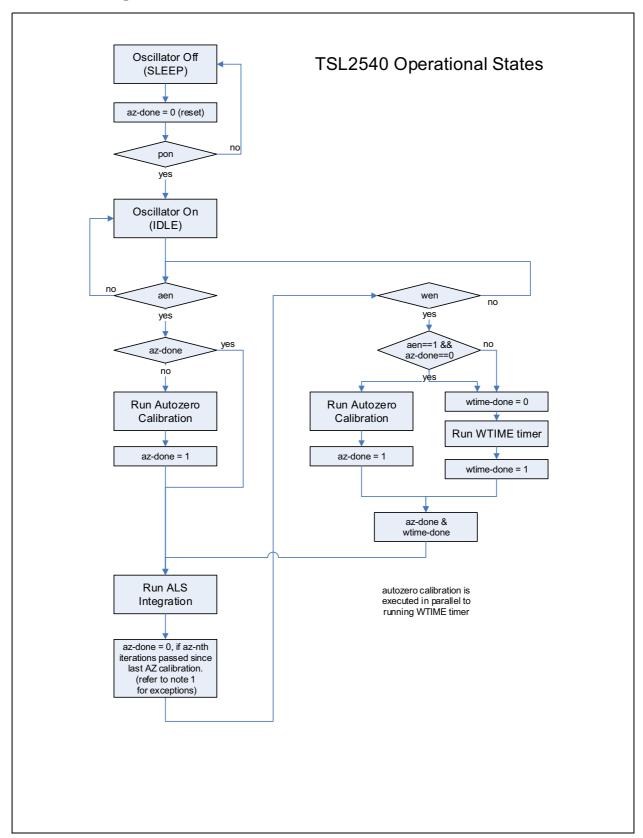
System State Machine

An internal state machine provides system control of the ALS, proximity detection, and power management features of the device. At power up, an internal power-on-reset initializes the device and puts it in a low power Sleep state. When a write on I²C bus to the Enable register (0x80) PON bit is set, the device transitions to the Idle state. If PON is disabled, the device will return to the Sleep state to save power. Otherwise, the device will remain in the Idle state until the ALS function is enabled. Once enabled, the device will execute the ALS and Wait states in sequence as indicated in Figure 12. Upon completion, the device will automatically begin a new ALS-Wait cycle as long as PON and AEN remain enabled. If the ALS function generates an interrupt and the Sleep-After-Interrupt (SAI) feature is enabled, the device will transition to the Sleep state and remain in a low-power mode until an I²C command is received clearing the interrupts in the STATUS register. See Interrupts for additional information.

ams Datasheet Page 9 **Document Feedback**



Figure 12: Detailed State Diagram



Note(s)

1. An I²C write to az-nth-iteration register, except of the value 00h (disable-az), resets az-done independent of actual cntrl-state. In consequence, a new autozero calibration will be started in advance to the next ALS integration cycle.

Page 10ams DatasheetDocument Feedback[v1-01] 2017-Oct-12



Register Description

Figure 13: Register Overview

| Address | Register Name | R/W | Register Function | Reset Value |
|---------|---------------|-----|----------------------------------------|-------------|
| 0x80 | ENABLE | R/W | Enables states and functions | 0x00 |
| 0x81 | ATIME | R/W | ALS integration time | 0x00 |
| 0x83 | WTIME | R/W | Wait time | 0x00 |
| 0x84 | AILTL | R/W | ALS interrupt low threshold low byte | 0x00 |
| 0x85 | AILTH | R/W | ALS interrupt low threshold high byte | 0x00 |
| 0x86 | AIHTL | R/W | ALS interrupt high threshold low byte | 0x00 |
| 0x87 | AIHTH | R/W | ALS interrupt high threshold high byte | 0x00 |
| 0x8C | PERS | R/W | ALS interrupt persistence filters | 0x00 |
| 0x8D | CFG0 | R/W | Configuration register zero | 0x80 |
| 0x90 | CFG1 | R/W | Configuration register one | 0x00 |
| 0x91 | REVID | R | Revision ID | 0x61 |
| 0x92 | ID | R | Device ID | 0xE4 |
| 0x93 | STATUS | R | Device status register | 0x00 |
| 0x94 | VISDATAL | R | Visible channel data low byte | 0x00 |
| 0x95 | VISDATAH | R | Visible channel data high byte | 0x00 |
| 0x96 | IRDATAL | R | IR channel data low byte | 0x00 |
| 0x97 | IRDATAH | R | IR channel data high byte | 0x00 |
| 0x9E | REVID2 | R | Auxiliary ID | 0x01 |
| 0x9F | CFG2 | R/W | Configuration register two | 0x04 |
| 0xAB | CFG3 | R/W | Configuration register three | 0x0C |
| 0xD6 | AZ_CONFIG | R/W | Autozero configuration | 0x7F |
| 0xDD | INTENAB | R/W | Interrupt enables | 0x00 |

Register Access:

- R = Read Only
- W = Write Only
- R/W = Read or Write
- SC = Self Clearing after access



Detailed Register Description

Enable Register (Address 0x80)

Figure 14: Enable Register

| Ac | ldr: 0x80 | | Enable | |
|-----|-----------|---------|--------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit | Bit Name | Default | Access | Bit Description |
| 7:4 | Reserved | 0000 | RW | Reserved. |
| 3 | WEN | 0 | RW | This bit activates the wait feature. Active high. |
| 2 | Reserved | 0 | RW | Reserved. |
| 1 | AEN | 0 | RW | This bit actives the ALS function. Active high. *Set AEN=1 and PON=1 in the same command to ensure auto-zero function is run prior to the first measurement. |
| 0 | PON | 0 | RW | This field activates the internal oscillator and ADC channels. Active high. |

Before activating AEN, preset each applicable operating mode registers and bits.

Page 12ams DatasheetDocument Feedback[v1-01] 2017-Oct-12



ATIME Register (Address 0x81)

Figure 15: **ATIME Register**

| Addr: 0x81 | | | | ATIME | | | | | | | |
|------------|----------|---------|--------|---------|--------|----------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------|-----------------------------------------------|-----------------------|---------------------|
| Bit | Bit Name | Default | Access | | Bit De | scription | | | | | |
| | | | | 0x00 RW | | intervals. 0 depends o maximum be able to | that specifies the 0x00 indicates 2.8 on the integration value increases reach ALS full sc ast 64*2.8ms. | Bms. The maxim n time. For every by 1024. This ma | um ALS value / 2.81ms, the eans that to | | |
| | | 0x00 | 0x00 | | | | | | Value | Integration Cycles | Integration Time |
| 7:0 | ATIME | | | | RW | 0x00 | 1 | 2.8ms | 1023 | | |
| | | | | | ı | | 1 | 0x01 2 5.6 | 5.6ms | 2047 | |
| | | | | | | ••• | ••• | ••• | ••• | | |
| | | | | 0x3F | 64 | 180ms | 65535 | | | | |
| | | | | ••• | ••• | ••• | ••• | | | | |
| | | | | 0xFF | 256 | 721ms | 65535 | | | | |

The ATIME register controls the integration time of the ALS ADCs. The timer is implemented with a down counter with 0x00 as the terminal count. The timer is clocked at a 2.8ms nominal rate. Loading 0x00 will generate a 2.8ms integration time, loading 0x01 will generate a 5.6ms integration time, and so forth. The RC oscillator runs at 8MHz nominal rate. This gets divided by 11 to generate the integration clock of 727kHz. One count in ATIME (nominal 2.8ms) are 2.81ms. This is 2048 integration clock cycles: 125ns*11*8*256=2.81ms.

ams Datasheet Page 13 **Document Feedback**



WTIME Register (Address 0x83)

Figure 16: WTIME Register

| Add | lr: 0x83 | | | WTIME | | | | |
|-----|----------|---------|--------|--------------------------------------|----------------------------|--------------------|----------------|---|
| Bit | Bit Name | Default | Access | Bit Description | | | | |
| | | | | Value that specifie 2.81ms increment | s the wait time betv s. | ween ALS cycles in | | |
| | | | | Value | Increments | Wait Time | | |
| | | 0x00 | 0x00 | | 0x00 | 1 | 2.8ms (33.8ms) | |
| 7:0 | WTIME | | | 0x00 | 0x00 | RW | 0x01 | 2 |
| | | | | | | | | |
| | | | 0x3F | 64 | 180ms (2.16s) | | | |
| | | | ••• | | | | | |
| | | | | 0xFF | 256 | 721ms (8.65s) | | |

The wait timer is implemented using a down counter. Wait time = (value +1) \times 2.8ms. If WLONG is enabled then Wait time = (value +1) \times 2.8ms \times 12.

AILTL Register (Address 0x84)

Figure 17: AILTL Register

| Addr: 0x84 | | | | AILTL |
|------------|----------|---------|--------|-----------------------------------------------------------|
| Bit | Bit Name | Default | Access | Bit Description |
| 7:0 | AILTL | 0x00 | RW | This register sets the low byte of the LOW ALS threshold. |

The Visible (Vis) channel is compared against low-going 16-bit threshold value set by AILTL and AILTH.

Page 14ams DatasheetDocument Feedback[v1-01] 2017-Oct-12



AILTH Register (Address 0x85)

Figure 18: **AILTH Register**

| Add | dr: 0x85 | | | AILTH |
|-----|----------|---------|--------|------------------------------------------------------------|
| Bit | Bit Name | Default | Access | Bit Description |
| 7:0 | AILTH | 0x00 | RW | This register sets the high byte of the LOW ALS threshold. |

The Visible (Vis) channel is compared against low-going 16-bit threshold value set by AILTL and AILTH.

The contents of the AILTH and AILTL registers are combined and treated as a sixteen bit threshold value. If the value generated by the C channel is below the AILTL/H threshold and the APERS value is reached, the AINT bit is asserted. If AIEN is set, then the INT pin will also assert.

When setting the 16-bit ALS threshold AILTL must be written first, immediately followed by AILTH. Internally, the lower 8-bits are buffered until the upper 8-bits are written. As the upper 8-bits are written both the high and low bytes are simultaneously latched as a 16-bit value.

AIHTL Register (Address 0x86)

Figure 19: **AIHTL Register**

| Addr: 0x86 | | AIHTL | | | |
|------------|----------|---------|--------|------------------------------------------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7:0 | AIHTL | 0x00 | RW | This register sets the low byte of the HIGH ALS threshold. | |

The Visible (Vis) channel is compared against high-going 16-bit threshold value set by AIHTL and AIHTH.

The contents of the AIHTH and AIHTL registers are combined and treated as a sixteen bit threshold value. If the value generated by the C channel is above the AIHTL/H threshold and the APERS value is reached, the AINT bit is asserted. If AIEN is set, then the INT pin will also assert. When setting the 16-bit ALS threshold AIHTL must be written first, immediately followed by AIHTH. Internally, the lower 8-bits are buffered until the upper 8-bits are written. As the upper 8-bits are written both the high and low bytes are simultaneously latched as a 16-bit value.

ams Datasheet Page 15 **Document Feedback**



AIHTH Register (Address 0x87)

Figure 20: AIHTH Register

| Addr: 0x87 | | AIHTH | | | |
|------------|----------|---------|--------|-------------------------------------------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7:0 | AIHTH | 0x00 | RW | This register sets the high byte of the HIGH ALS threshold. | |

The Visible (Vis) channel is compared against high-going 16-bit threshold value set by AIHTL and AIHTH.

The contents of the AIHTH and AIHTL registers are combined and treated as a sixteen bit threshold value. If the value generated by the C channel is above the AIHTL/H threshold and the APERS value is reached, the AINT bit is asserted. If AIEN is set, then the INT pin will also assert.

When setting the 16-bit ALS threshold AIHTL must be written first, immediately follow by AIHTH. Internally, the lower 8-bits are buffered until the upper 8-bits are written. As the upper 8-bits are written both the high and low bytes are simultaneously latched as a 16-bit value.

Page 16

Document Feedback

[v1-01] 2017-Oct-12



PERS Register (Address 0x8C)

Figure 21: PERS Register

| Add | Addr: 0x8C | | PERS | | | | |
|-----|------------|---------|--------|----------------------------------------|----------------------------------------|--|--|
| Bit | Bit Name | Default | Access | | Bit Description | | |
| 7:4 | Reserved | 0000 | RW | Reserved. | | | |
| | | | | This register | r sets the ALS persistence filter. | | |
| | | | | 0 | Every ALS cycle | | |
| | | | | 1 | Any value outside ALS thresholds | | |
| | | | | 2 | 2 consecutive ALS values out of range | | |
| | | | | 3 | 3 consecutive ALS values out of range | | |
| | | | | 4 | 5 consecutive ALS values out of range | | |
| 3:0 | APERS | 0000 | RW | 5 | 10 consecutive ALS values out of range | | |
| | | | | 6 | 15 consecutive ALS values out of range | | |
| | | | | 7 | 20 consecutive ALS values out of range | | |
| | | | | | | | |
| | | | | 13 | 50 consecutive ALS values out of range | | |
| | | | 14 | 55 consecutive ALS values out of range | | | |
| | | | | 15 | 60 consecutive ALS values out of range | | |

The frequency of consecutive visible channel results outside of threshold limits are counted; this count value is compared against the APEARS value. If the counter is equal to the APERS setting an interrupt is asserted. Any time a clear channel result is inside the threshold values the counter is cleared.



CFG0 Register (Address 0x8D)

Figure 22: CFG0 Register

| Addr: 0x8D | | CFG0 | | | |
|------------|----------|---------|--------|--------------------------------------------------------------------------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7:3 | Reserved | 10000 | RW | This field must be set to the default value. | |
| 2 | WLONG | 0 | RW | When Wait Long is asserted the wait period as set by WTIME is increased by a factor of 12. | |
| 1:0 | Reserved | 00 | RW | This field must be set to the default value. | |

The wait timer is implemented using a down counter. Wait time = (value +1) \times 2.8ms. If WLONG is enabled then Wait time = (value +1) \times 2.8ms \times 12.

Page 18ams DatasheetDocument Feedback[v1-01] 2017-Oct-12



CFG1 Register (Address 0x90)

Figure 23: CFG1 Register

| Ad | Addr: 0x90 | | | CFG1 | | |
|-----|--------------|---------|------------------------|---------------------------------|---------------|--|
| Bit | Bit Name | Default | Access Bit Description | | | |
| 7:2 | Reserved | 000000 | RW | Reserved. | | |
| | | | | This field sets the gain of the | e ALS sensor. | |
| | | | | Value | ALS Gain | |
| 1:0 | AGAIN | 00 | RW | 0 | 1x | |
| 1.0 | 1:0 AGAIN 00 | 00 | KVV | 1 | 4x | |
| | | | 2 | 16x | | |
| | | | | 3 | 64x | |

REVID Register (Address 0x91)

Figure 24: REVID Register

| Addr: 0x91 | | REVID | | | |
|------------|----------|---------|--------|-------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7:3 | Reserved | 01100 | RO | Reserved. | |
| 2:0 | REV_ID | 001 | RO | Device revision number. | |

ams Datasheet Page 19
[v1-01] 2017-Oct-12 Document Feedback



ID Register (Address 0x92)

Figure 25: ID Register

| Addr | : 0x92 | ID | | | |
|------|----------|---------|--------|-----------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7:2 | ID | 111001 | RO | Device type identification. | |
| 1:0 | Reserved | 00 | RO | Reserved. | |

Status Register (Address 0x93)

Figure 26: Status Register

| Addr: 0x93 | | Status Register | | | |
|------------|----------|-----------------|--------|------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7 | ASAT | 0 | R, SC | The Analog Saturation flag signals that the ALS results may be unreliable due to saturation of the AFE. | |
| 6:5 | Reserved | 00 | R, SC | Reserved. | |
| 4 | AINT | 0 | R, SC | The ALS Interrupt flag indicates that ALS results (visible channel) have exceeded thresholds and persistence settings. | |
| 3 | CINT | 0 | R, SC | The Calibration Interrupt flag indicates that calibration has completed. | |
| 2:0 | Reserved | 000 | R, SC | Reserved. | |

All flags in this register can be cleared by setting the bit high. Alternatively, if the CFG3.int_read_clear bit is set, then simply reading this register automatically clears all eight flags.

VISDATAL Register (Address 0x94)

Figure 27: VISDATAL Register

| Addr: 0x94 | | VISDATAL | | | |
|------------|----------|----------|--------|-------------------------------------------------------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7:0 | VISDATAL | 0x00 | RO | This register contains the low byte of the 16-bit visible channel data. | |

Page 20ams DatasheetDocument Feedback[v1-01] 2017-Oct-12



VISDATAH Register (Address 0x95)

Figure 28: VISDATAH Register

| Addr: 0x95 | | VISDATAH | | | |
|------------|----------|----------|--------|--------------------------------------------------------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7:0 | VISDATAH | 0x00 | RO | This register contains the high byte of the 16-bit visible channel data. | |

IRDATAL Register (Address 0x96)

Figure 29: IRDATAL Register

| Addr: 0x96 | | IRDATAL | | | |
|------------|----------|---------|--------|--------------------------------------------------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7:0 | IRDATAL | 0x00 | RO | This register contains the low byte of the 16-bit IR channel data. | |

IRDATAH Register (Address 0x97)

Figure 30: IRDATAH Register

| Addr: 0x97 | | IRDATAH | | | |
|------------|----------|---------|--------|---------------------------------------------------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7:0 | IRDATAH | 0x00 | RO | This register contains the high byte of the 16-bit IR channel data. | |

REVID2 Register (Address 0x9E)

Figure 31: REVID2 Register

| Addr: 0x9E | | REVID2 | | | |
|------------|----------|---------|--------|-------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7:4 | Reserved | 0000 | RO | Reserved. | |
| 3:0 | REVID2 | 0001 | RO | Package identification. | |

ams Datasheet Page 21
[v1-01] 2017-Oct-12 Document Feedback



CFG2 Register (Address 0x9F)

Figure 32: **CFG2** Register

| Addr: 0x9F | | CFG2 | | | |
|------------|----------|---------|--------|---------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7:5 | Reserved | 000 | RW | Reserved. | |
| 4 | AGAINMAX | 0 | RW | This bit adjusts the overall ALS gain factor. See Figure 33 for recommended settings and corresponding overall ALS gain factor. | |
| 3 | Reserved | 0 | RW | Reserved. | |
| 2 | AGAINL | 1 | RW | This bit adjusts the overall ALS gain factor. See Figure 33 for recommended settings and corresponding overall ALS gain factor. | |
| 1:0 | Reserved | 00 | RW | Reserved. | |

The ALS gain can be adjusted by setting the two AGAIN bits as well as the AGAINMAX and AGAINL bits which yields an overall range from ½x to 128x.

Figure 33: **AGAIN Range**

| AGAIN[1] | AGAIN[0] | AGAINMAX | AGAINL | Overall ALS Gain |
|----------|----------|----------|--------|------------------|
| 0 | 0 | 0 | 0 | 1/2 |
| 0 | 0 | 0 | 1 | 1 |
| 0 | 1 | 0 | 1 | 4 |
| 1 | 0 | 0 | 1 | 16 |
| 1 | 1 | 0 | 1 | 64 |
| 1 | 1 | 1 | 1 | 128 |

Page 22 ams Datasheet **Document Feedback** [v1-01] 2017-Oct-12



CFG3 Register (Address 0xAB)

Figure 34: CFG3 Register

| Addr: 0xAB | | CFG3 | | | | | | | |
|------------|----------------|---------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------|------|------------|---|---|
| Bit | Bit Name | Default | Access | Bit Description | | | | | |
| 7 | INT_READ_CLEAR | 0 | RW | If the Interrupt-Clear-by-Read bit is set, then all flag bits in the STATUS register will be reset whenever the STATUS register is read over I ² C. | | | | | |
| 6:5 | Reserved | 10 | RW | Reserved. | | | | | |
| | | 0 | | | ter Interrupt k Iow power m | | | | |
| | | | | PON | SAI | INT | Oscillator | | |
| 4 | SAI | | 0 RW | 0 | 0 | 0 RW | 0 | Х | Х |
| | | | | 1 | 0 | Х | ON | | |
| | | | | 1 | 1 | 1 | ON | | |
| | | | | 1 | 1 | 0 | OFF | | |
| 3:0 | Reserved | 1100 | RW | Reserved. | | | | | |

The SAI bit sets the device operational mode following the completion of an ALS or proximity cycle. If AINT and AIEN are both set or if PINT and PIEN are both set, causing an interrupt on the INT pin, and the SAI bit is set, then the oscillator will deactivate. The Device will appear as if PON = 0, however, PON will read as 1. The device can only be reactivated (oscillator enabled) by clearing the interrupts in the STATUS register.

ams Datasheet Page 23
[v1-01] 2017-Oct-12 Document Feedback



AZ_CONFIG Register (Address 0xD6)

Figure 35: **AZ_CONFIG Register**

| Addr: 0xD6 | | AZ_CONFIG | | | |
|------------|----------------------|-----------|--------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Bit | Bit Name | Default | Access | Bit Description | |
| 7 | Reserved | 0 | RW | Reserved. | |
| 6:0 | AZ_NTH_ ITERATION | 1111111 | RW | Run autozero automatically before every n th ALS cycle (00h = never, n = every n th ALS cycle, and 7Fh = only before the first ALS cycle). | |

INTENAB Register (Address 0xDD)

Figure 36: **INTENAB** Register

| Addr: 0xDD | | | | INTENAB |
|------------|----------|---------|--------|----------------------------------|
| Bit | Bit Name | Default | Access | Bit Description |
| 7 | ASIEN | 0 | RW | ALS Saturation Interrupt Enable. |
| 6:5 | Reserved | 00 | RW | Reserved. |
| 4 | AIEN | 0 | RW | ALS Interrupt Enable. |
| 3:0 | Reserved | 0000 | RW | Reserved. |

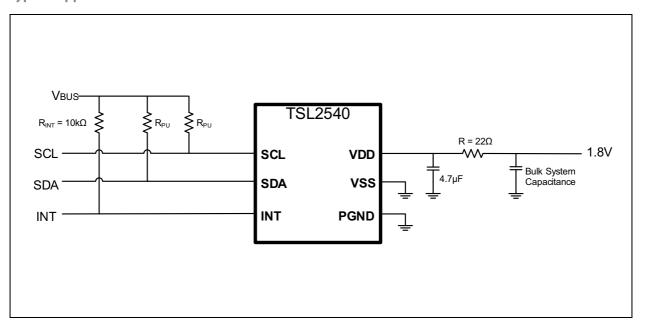
Page 24 ams Datasheet **Document Feedback** [v1-01] 2017-Oct-12



Application Information

Schematic

Figure 37: **Typical Applications Circuit**



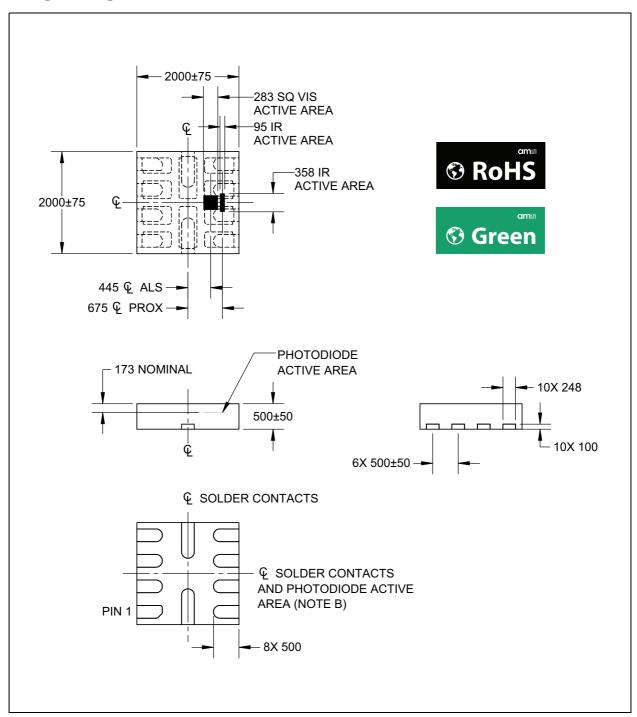
- 1. The value of the I²C pull up resistors RPU should be based on the 1.8V bus voltage, system bus speed and trace capacitance.
- 2. The bulk capacitor can affect the stability of a regulated supply output and should be chosen with the regulator characteristics in
- 3. VSS and PGND should be connected to the same solid ground plane as close to the device as possible.

ams Datasheet Page 25 **Document Feedback**



Package Drawings & Markings

Figure 38: Package Drawing



Note(s):

- 1. All linear dimensions are in micrometers. Dimension tolerance is $\pm 20 \mu m$ unless otherwise stated.
- 2. The die is centered vertically within the package within a tolerance of $\pm 75 \mu m.$
- 3. Package top surface is molded with an electrically nonconductive clear plastic compound having an index of refraction of 1.55.
- 4. Contact finish is Copper Alloy A194 with pre-plated NiPdAu lead finish.
- 5. This package contains no lead (Pb).
- 6. This drawing is subject to change without notice.

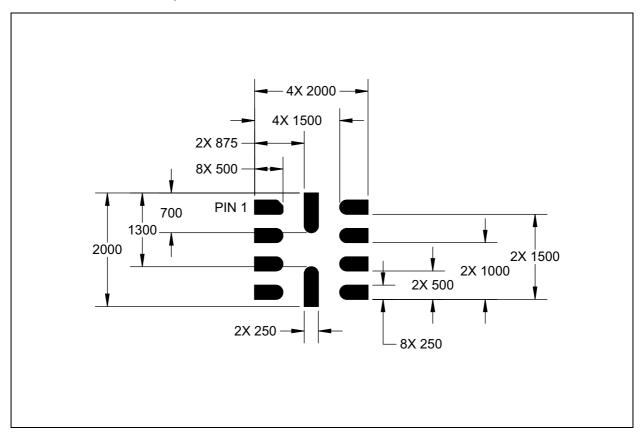
Page 26

Document Feedback

[v1-01] 2017-Oct-12



Figure 39: **Recommended PCB Pad Layout**



Note(s):

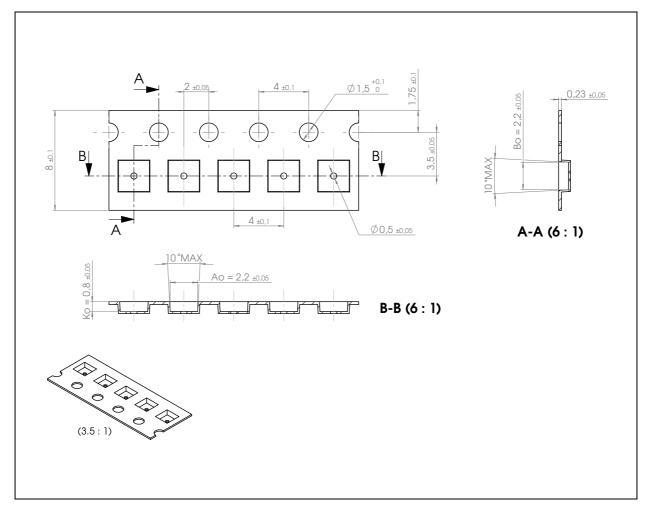
- 1. All dimensions are in micrometers.
- 2. Dimension tolerances are $50\mu m$ unless otherwise noted.
- 3. This drawing is subject to change without notice.

ams Datasheet Page 27 **Document Feedback**



Tape & Reel Information

Figure 40: **Tape and Reel Information**



Note(s):

- 1. All linear dimensions are in millimeters.
- 2. For missing tolerances and dimensions, refer to EIA-481.

Page 28 ams Datasheet [v1-01] 2017-Oct-12



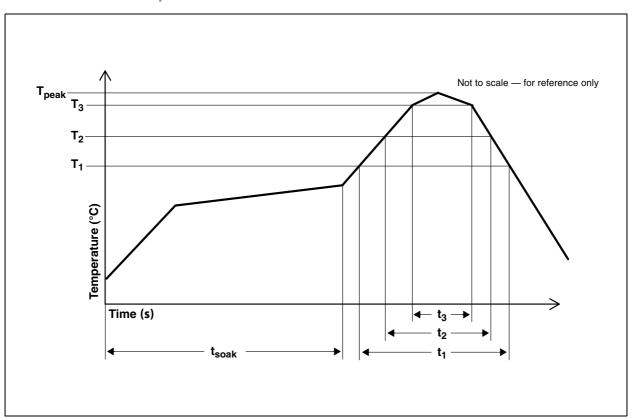
Soldering & Storage Information

The QFN package has been tested and has demonstrated an ability to be reflow soldered to a PCB substrate. The solder reflow profile describes the expected maximum heat exposure of components during the solder reflow process of product on a PCB. Temperature is measured on top of component. The components should be limited to a maximum of three passes through this solder reflow profile.

Figure 41: Solder Reflow Profile

| Parameter | Reference | Device |
|-------------------------------------------------------|-------------------|----------------|
| Average temperature gradient in preheating | | 2.5°C/s |
| Soak time | t _{SOAK} | 2 to 3 minutes |
| Time above 217°C (T ₁) | t ₁ | Max 60s |
| Time above 230°C (T ₂) | t ₂ | Max 50s |
| Time above T _{peak} - 10°C (T ₃) | t ₃ | Max 10s |
| Peak temperature in reflow | T _{peak} | 260°C |
| Temperature gradient in cooling | | Max - 5°C/s |

Figure 42: Solder Reflow Profile Graph



ams Datasheet Page 29
[v1-01] 2017-Oct-12 Document Feedback



Storage Information

Moisture Sensitivity Optical characteristics of the device can be adversely affected during the soldering process by the release and vaporization of moisture that has been previously absorbed into the package. To ensure the package contains the smallest amount of absorbed moisture possible, each device is baked prior to being dry packed for shipping. Devices are dry packed in a sealed aluminized envelope called a moisture-barrier bag with silica gel to protect them from ambient moisture during shipping, handling, and storage before use.

Shelf Life

The calculated shelf life of the device in an unopened moisture barrier bag is 12 months from the date code on the bag when stored under the following conditions:

• Shelf Life: 12 months

• Ambient Temperature: <40°C

• Relative Humidity: <90%

Rebaking of the devices will be required if the devices exceed the 12 month shelf life or the Humidity Indicator Card shows that the devices were exposed to conditions beyond the allowable moisture region.

Floor Life

The QFN package has been assigned a moisture sensitivity level of MSL 3. As a result, the floor life of devices removed from the moisture barrier bag is 168 hours from the time the bag was opened, provided that the devices are stored under the following conditions:

• Floor Life: 168 hours

• Ambient Temperature: <30°C

• Relative Humidity: <60%

If the floor life or the temperature/humidity conditions have been exceeded, the devices must be rebaked prior to solder reflow or dry packing.

Rebaking Instructions

When the shelf life or floor life limits have been exceeded, rebake at 50°C for 12 hours.

Page 30 ams Datasheet
Document Feedback [v1-01] 2017-Oct-12



Ordering & Contact Information

Figure 43: Ordering Information

| Ordering Code | I ² C Bus | I ² C Address | Delivery Form | Delivery Quantity |
|---------------|----------------------|--------------------------|---------------|-------------------|
| TSL25403 | 1.8V | 39h | Tape and Reel | 10000 pcs/reel |
| TSL25403M | 1.8V | 39h | Tape and Reel | 1000 pcs/reel |

Buy our products or get free samples online at:

www.ams.com/ICdirect

Technical Support is available at: www.ams.com/Technical-Support

Provide feedback about this document at:

www.ams.com/Document-Feedback

For further information and requests, e-mail us at:

ams_sales@ams.com

 $For \ sales \ of fices, \ distributors \ and \ representatives, \ please \ visit:$

www.ams.com/contact

Headquarters

ams AG Tobelbader Strasse 30 8141 Premstaetten Austria, Europe

Tel: +43 (0) 3136 500 0 Website: www.ams.com

ams Datasheet Page 31
[v1-01] 2017-Oct-12 Document Feedback



RoHS Compliant & ams Green Statement

RoHS: The term RoHS compliant means that ams AG products fully comply with current RoHS directives. Our semiconductor products do not contain any chemicals for all 6 substance categories, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, RoHS compliant products are suitable for use in specified lead-free processes.

ams Green (RoHS compliant and no Sb/Br): ams Green defines that in addition to RoHS compliance, our products are free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material).

Important Information: The information provided in this statement represents ams AG knowledge and belief as of the date that it is provided. ams AG bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. ams AG has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. ams AG and ams AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

Page 32

Document Feedback

[v1-01] 2017-Oct-12



Copyrights & Disclaimer

Copyright ams AG, Tobelbader Strasse 30, 8141 Premstaetten, Austria-Europe. Trademarks Registered. All rights reserved. The material herein may not be reproduced, adapted, merged, translated, stored, or used without the prior written consent of the copyright owner.

Devices sold by ams AG are covered by the warranty and patent indemnification provisions appearing in its General Terms of Trade. ams AG makes no warranty, express, statutory, implied, or by description regarding the information set forth herein. ams AG reserves the right to change specifications and prices at any time and without notice. Therefore, prior to designing this product into a system, it is necessary to check with ams AG for current information. This product is intended for use in commercial applications. Applications requiring extended temperature range, unusual environmental requirements, or high reliability applications, such as military, medical life-support or life-sustaining equipment are specifically not recommended without additional processing by ams AG for each application. This product is provided by ams AG "AS IS" and any express or implied warranties, including, but not limited to the implied warranties of merchantability and fitness for a particular purpose are disclaimed.

ams AG shall not be liable to recipient or any third party for any damages, including but not limited to personal injury, property damage, loss of profits, loss of use, interruption of business or indirect, special, incidental or consequential damages, of any kind, in connection with or arising out of the furnishing, performance or use of the technical data herein. No obligation or liability to recipient or any third party shall arise or flow out of ams AG rendering of technical or other services.

ams Datasheet Page 33 **Document Feedback**



Document Status

| Document Status | Product Status | Definition |
|--------------------------|-----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product Preview | Pre-Development | Information in this datasheet is based on product ideas in the planning phase of development. All specifications are design goals without any warranty and are subject to change without notice |
| Preliminary Datasheet | Pre-Production | Information in this datasheet is based on products in the design, validation or qualification phase of development. The performance and parameters shown in this document are preliminary without any warranty and are subject to change without notice |
| Datasheet | Production | Information in this datasheet is based on products in ramp-up to full production or full production which conform to specifications in accordance with the terms of ams AG standard warranty as given in the General Terms of Trade |
| Datasheet (discontinued) | Discontinued | Information in this datasheet is based on products which conform to specifications in accordance with the terms of ams AG standard warranty as given in the General Terms of Trade, but these products have been superseded and should not be used for new designs |

Page 34ams DatasheetDocument Feedback[v1-01] 2017-Oct-12



Revision Information

| Changes from 1-00 (2017-Apr-20) to current revision 1-01 (2017-Oct-12) | Page |
|------------------------------------------------------------------------|------|
| Updated notes below Figure 38 | 26 |
| Updated notes below Figure 39 | 27 |

Note(s):

- 1. Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.
- 2. Correction of typographical errors is not explicitly mentioned.

ams Datasheet Page 35 Document Feedback



Content Guide

1 General Description

- 1 Key Benefits & Features
- 2 Applications
- 2 Block Diagram
- 3 Pin Assignment
- 4 Absolute Maximum Ratings
- **5 Electrical Characteristics**
- **6 Typical Operating Characteristics**

8 Detailed Description

- 8 Ambient Light Sensing
- 8 I²C Characteristics
- 8 I²C Write Transaction
- 8 I²C Read Transaction
- 9 Timing Diagrams

10 Register Description

- 10 Register Overview
- 11 Detailed Register Description
- 11 Enable Register (Address 0x80)
- 12 ATIME Register (Address 0x81)
- 13 WTIME Register (Address 0x83)
- 13 AILTL Register (Address 0x84)
- 14 AILTH Register (Address 0x85)
- 14 AIHTL Register (Address 0x86)
- 15 AIHTH Register (Address 0x87)
- 16 PERS Register (Address 0x8C)
- 17 CFG0 Register (Address 0x8D)
- 18 CFG1 Register (Address 0x90)
- 18 REVID Register (Address 0x91)
- 19 ID Register (Address 0x92)
- 19 Status Register (Address 0x93)
- 19 VISDATAL Register (Address 0x94)
- 20 VISDATAH Register (Address 0x95)20 IRDATAL Register (Address 0x96)
- 20 IRDATAH Register (Address 0x97)
- 21 CFG2 Register (Address 0x9F)
- 21 Cl dz Negistei (Address 0X)1)
- 22 CFG3 Register (Address 0xAB)
- AZ_CONFIG Register (Address 0xD6)INTENAB Register (Address 0xDD)
- 24 Application Information
- 24 Schematic
- 25 Package Drawings & Markings
- 27 Tape & Reel Information

Page 36

Document Feedback

[v1-01] 2017-Oct-12



- 28 Soldering & Storage Information
- 29 Storage Information
- 29 Shelf Life
- 29 Floor Life
- 29 Rebaking Instructions
- 30 Ordering & Contact Information
- 31 RoHS Compliant & ams Green Statement
- 32 Copyrights & Disclaimer
- 33 Document Status
- 34 Revision Information

ams Datasheet Page 37
[v1-01] 2017-Oct-12 Document Feedback